

-20V P-Channel Enhancement Mode MOSFET

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DESCRIPTION

The STP7407 is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density. advanced trench technology to provide excellent $R_{DS(ON)}$.

This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, and low in-line power loss are needed in a very small outline surface mount package.

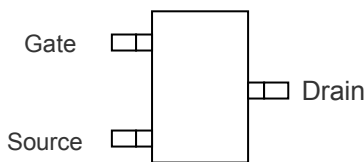
FEATURE

- ◆ -20V/-3.4A, $R_{DS(ON)} = 88m\Omega(yp.)@V_{GS} = -4.5V$
- ◆ -20V/-2.4A, $R_{DS(ON)} = 110m\Omega(yp.)@V_{GS} = -2.5V$
- ◆ -20V/-1.7A, $R_{DS(ON)} = 150m\Omega(yp.)@V_{GS} = -1.8V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability
- ◆ This is a RoHS compliance
- ◆ SOT-323 package design

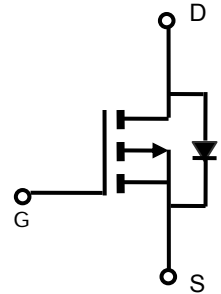
APPLICATIONS

- ◆ Power Management in Note book
- ◆ Portable Equipment
- ◆ DSC
- ◆ LCD Display inverter
- ◆ Battery Powered System
- ◆ DC/DC Converter
- ◆ Load Switch

PIN CONFIGURATION

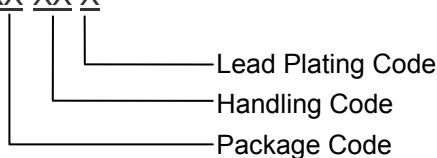


TOP VIEW
SOT-323



P-Channel

PART NUMBER INFORMATION

<p>STP7407XX-XX X</p> 	<p>Lead Plating Code G : Lead-free product. This product is Green compliant</p> <p>Handling Code TR : Tape&Reel</p> <p>Package Code J2 : SOT-323</p>
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ORDERING INFORMATION

Part Number	Package Code	Package	Shipping
STP7407J2-TRG	J2	SOT-323	3000 / Tape&Reel

※ SOT-23 : Only available in tape and reel packaging. (A reel contains 3000 devices)

※ G : This product is RoHS compliant.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C Unless otherwise noted)

Symbol	Parameter	Typical	Unit
V _{DSS}	Drain-Source Voltage	-20	V
V _{GSS}	Gate-Source Voltage	±12	V
I _D	Continuous Drain Current (T _J =150°C)	V _{GS} =-4.5V	-3.4
I _{DM}	Pulsed Drain Current	-6	A
I _S	Continuous Source Current (Diode Conduction)	-1.4	A
P _D	Power Dissipation	T _A =25°C T _A =70°C	330 210
T _J	Operation Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55/150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

THERMAL DATA

Symbol	Parameter	Min	Typ	Max	Unit
R _{θJA}	Thermal Resistance-Junction to Ambient			110	°C/W

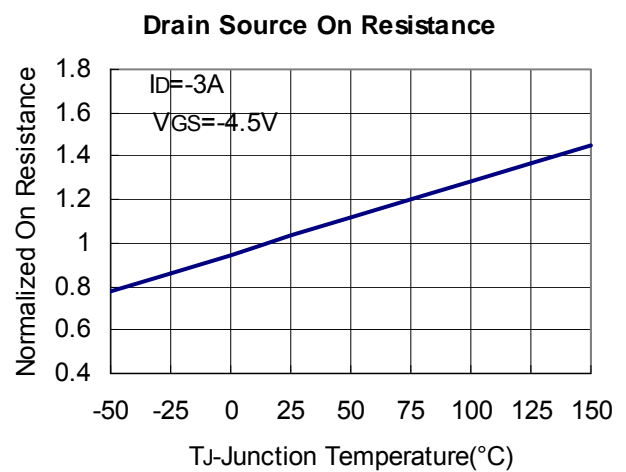
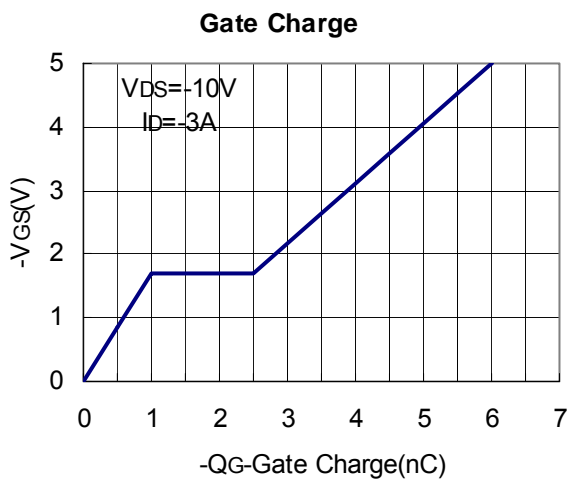
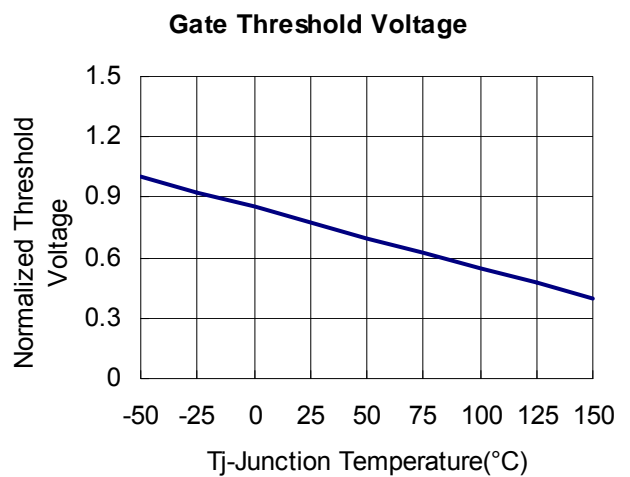
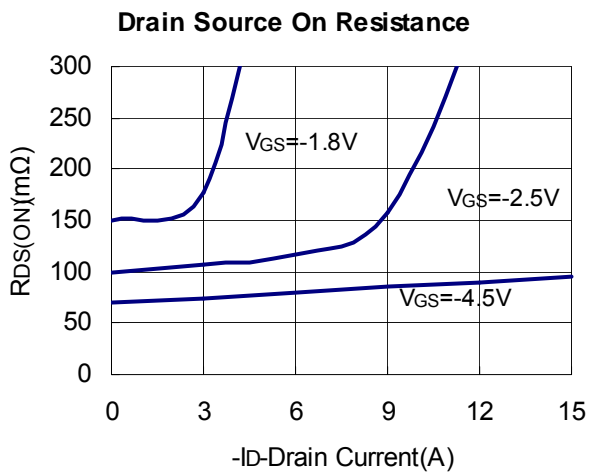
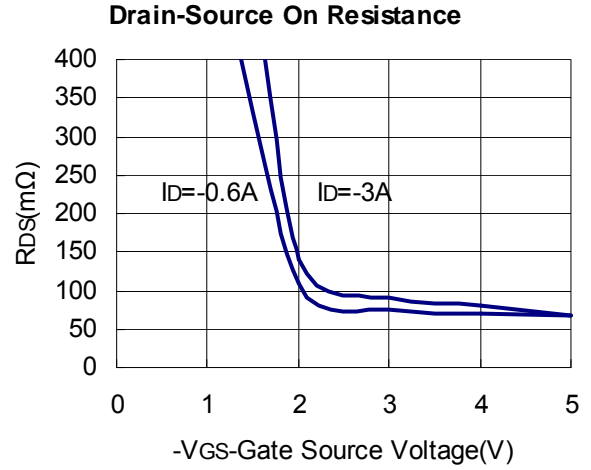
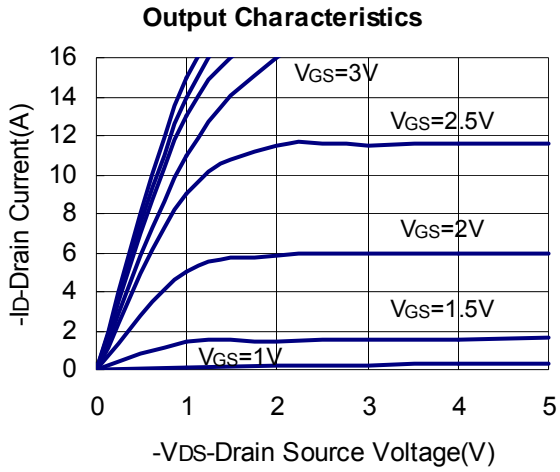
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-20			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4		-1.0	V
I_{GSS}	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-20V, V_{GS}=0V$			-1	μA
		$V_{DS}=-20V, V_{GS}=0V$ $T_J=55^\circ\text{C}$			-10	
$R_{DS(ON)}$	Drain-source On-Resistance	$V_{GS}=-4.5V, I_D=-3.4A$		88	95	m Ω
		$V_{GS}=-2.5V, I_D=-2.4A$		110	125	
		$V_{GS}=-1.8V, I_D=-1.7A$		150	170	
G_{fs}	Forward Transconductance	$V_{DS}=-5V, I_D=-2.8A$		6.5		S
Source-Drain Diode						
V_{SD}	Diode Forward Voltage	$I_S=-1.6A, V_{GS}=0V$		-0.7	-1.2	V
Dynamic Parameters						
Q_g	Total Gate Charge	$V_{DS}=-10V$ $V_{GS}=-4.5V$ $I_D=-3.2A$		7	10	nC
Q_{gs}	Gate-Source Charge			1.8		
Q_{gd}	Gate-Drain Charge			2		
C_{iss}	Input Capacitance	$V_{DS}=-10V$ $V_{GS}=0V$ $f=1\text{MHz}$		415		pF
C_{oss}	Output Capacitance			223		
C_{riss}	Reverse Transfer Capacitance			87		
$t_{d(on)}$	Turn-On Time	$V_{DD}=-10V$ $R_L=10\Omega$ $I_D=-1.0A$		13	25	nS
t_r				36	60	
$t_{d(off)}$	Turn-Off Time	$V_{GEN}=-4.5V$ $R_G=6\Omega$		42	70	
t_f				34	60	

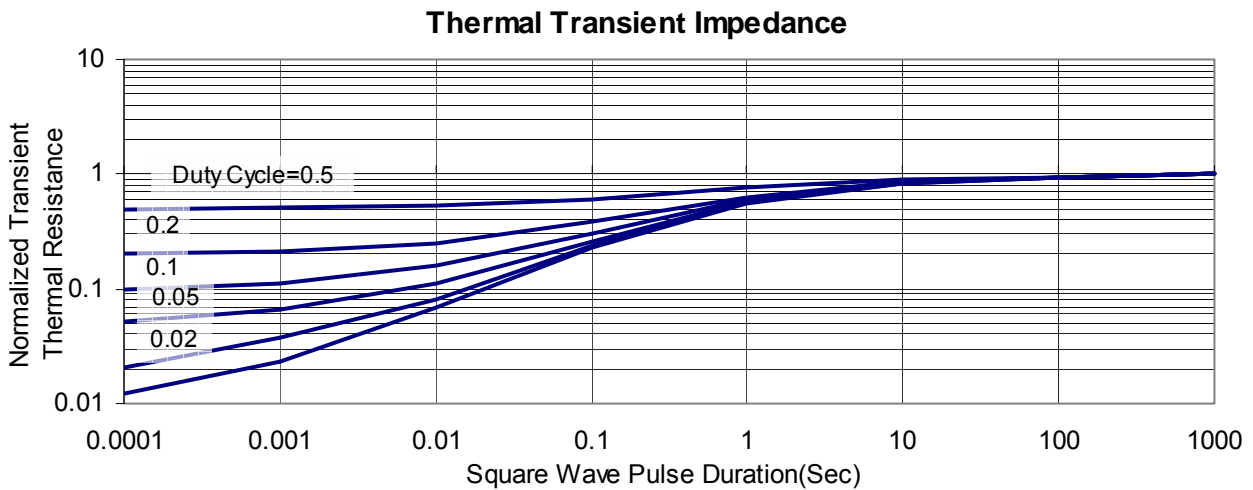
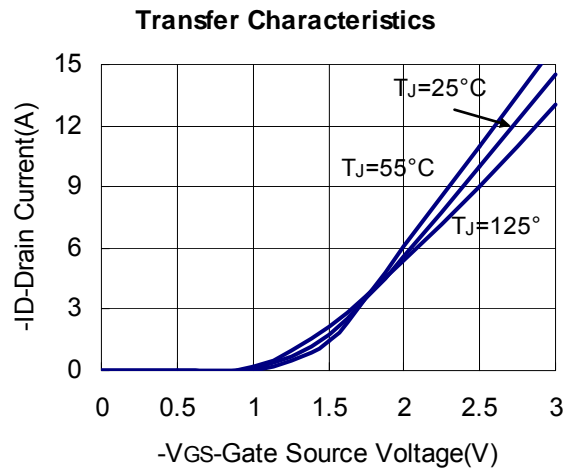
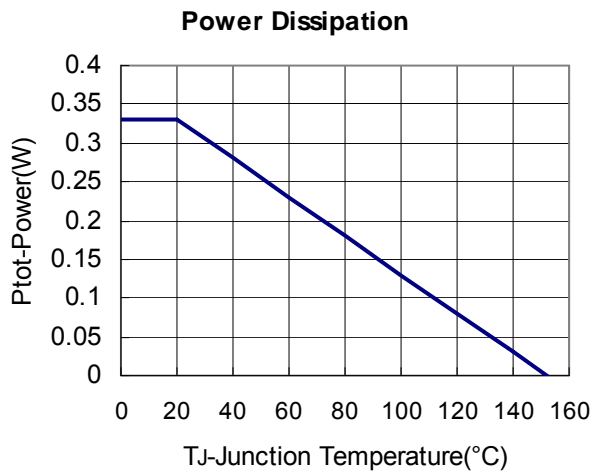
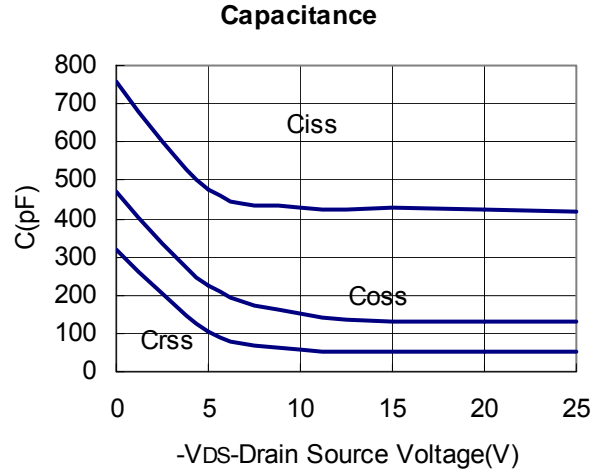
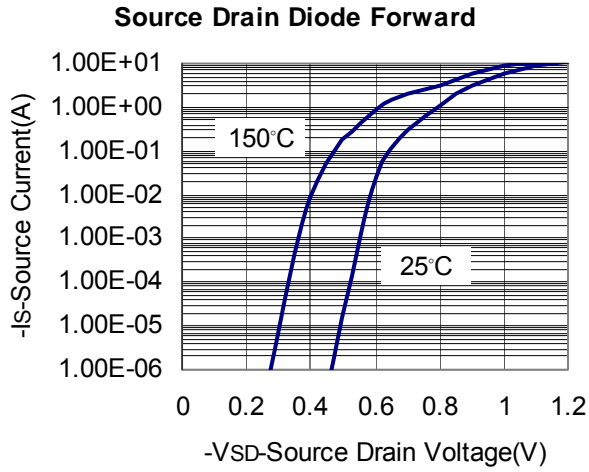
Note : 1. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

2. Static parameters are based on package level with recommended wire-bonding

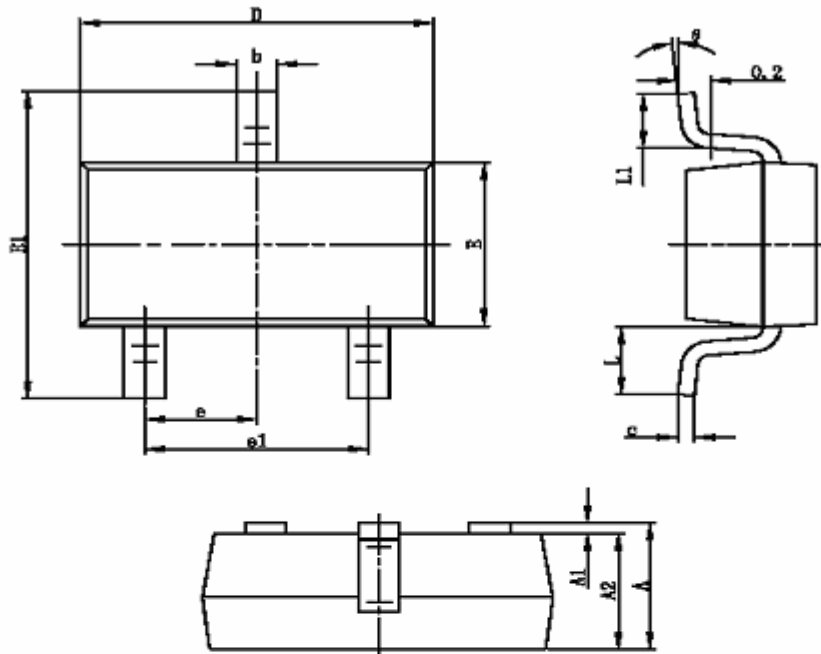
■ TYPICAL CHARACTERISTICS (25°C Unless Note)



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■ SOT-323 PACKAGE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.525REF		0.021REF	
L1	0.260	0.460	0.010	0.018
• •	0°	8°	0°	8°